© C	terial Compositi opyright 2005. IPC, E national and Pan-Am	Bannockbu	urn, Illinois. A	ll rights reserved untions.	under both	This docum level parts, t	ent is a declar the declaration	ation of th	ne substance asses all low	s within the m er level mater	anufacture ials for wh	er listed ite nich the ma	m. Note: if nufacturer	the item is an as has engineering	ssembly with lower responsibility.	
					Form Type * Distribute						us Materia	rials and Mfg Information				
Supplier Information	L															
Company name*			Company unique ID			Unique ID Authority					Response Date*					
onsemi												2025-06-04				
Contact Name			Title - Contact				Phone - Contact*					Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Authorized Representative*			Title - Representative			Phone - Representative*				Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Da	te Vers	Version Manufacturing Site		W	eight*	UOM	Unit Type		
		NVBG190N65S3F		SF3 FRFET Auto, 190mohm, D2PAK 7L		PAK 7L	2025-06-04			СРА		15	72.945	mg	Each	
Manufacturing Proce	ess Information			·												
Terminal Plating / Grid Array Material Term		erminal Base	al Base Alloy J-STD-020 MSL Rati		Rating	Peak Process Body Temperature Max		re Max Tim	e at Peak '	ak Temperature Number of Reflow Cycles		cles				
Matte Tin (Sn) - annealed CU			U Alloy	Alloy 1			260 C 30			seconds 3						
Comments																
level 1 - maximum time at j	peak temperature d	uring sold	dering is 10-3	0 seconds												
For more information rega	rding material com	position p	olease refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	6.75	mg	Supplier	Silicon (Si)	7440-21-3		6.75	mg
Die Attach Solder	2.271	mg	Supplier	Silver (Ag)	7440-22-4		0.0568	mg
			А	Lead (Pb)	7439-92-1	7a	2.1688	mg
			Supplier	Tin (Sn)	7440-31-5		0.0454	mg
Lead Frame	921.0	mg	В	Nickel (Ni)	7440-02-0		9.21	mg
			Supplier	Copper (Cu)	7440-50-8		911.79	mg
Mold Compound-Black	626.0	mg		Epoxy resin	proprietary data		18.78	mg
			Supplier	Phenolic Resin	Proprietary Data		9.39	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		93.9	mg
			Supplier	Carbon Black (C)	1333-86-4		3.13	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		500.8	mg
Plating	0.224	mg	Supplier	Tin (Sn)	7440-31-5		0.224	mg
Wire Bond - Al	16.7	mg	Supplier	Aluminum (Al)	7429-90-5		16.7	mg